



62mm C-Serien Modul mit schnellem IGBT2 für hochfrequentes Schalten
62mm C-series module with the fast IGBT2 for high-frequency switching

暫定データ
Preliminary Data

IGBT-ブレーキチョッパー / IGBT, Brake-Chopper
最大定格 / Maximum Rated Values

コレクタ・エミッタ間電圧 Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
連続DCコレクタ電流 Continuous DC collector current	$T_C = 60^{\circ}\text{C}, T_{vj\max} = 150^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}, T_{vj\max} = 150^{\circ}\text{C}$	$I_{C\text{nom}}$ I_C	300 370	A A
繰り返しピークコレクタ電流 Repetitive peak collector current	$t_P = 1\text{ms}$	I_{CRM}	600	A
トータル損失 Total power dissipation	$T_C = 25^{\circ}\text{C}, T_{vj\max} = 150$	P_{tot}	1950	W
ゲート・エミッタ間ピーク電圧 Gate-emitter peak voltage		V_{GES}	+/-20	V

電気的特性 / Characteristic Values

			min.	typ.	max.		
コレクタ・エミッタ間飽和電圧 Collector-emitter saturation voltage	$I_C = 300\text{A}, V_{GE} = 15\text{V}$ $I_C = 300\text{A}, V_{GE} = 15\text{V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	$V_{CE\text{sat}}$	3,20 3,85	3,75	V V	
ゲート・エミッタ間しきい値電圧 Gate threshold voltage	$I_C = 12,0\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		$V_{G\text{Eth}}$	4,5	5,5	6,5	V
ゲート電荷量 Gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$		Q_G	3,20		μC	
内蔵ゲート抵抗 Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		$R_{G\text{int}}$	1,0		Ω	
入力容量 Input capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		C_{ies}	20,0		nF	
帰還容量 Reverse transfer capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		C_{res}	1,40		nF	
コレクタ・エミッタ間遮断電流 Collector-emitter cut-off current	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$		I_{CES}		5,0	mA	
ゲート・エミッタ間漏れ電流 Gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$		I_{GES}		400	nA	
ターンオン遅れ時間 (誘導負荷) Turn-on delay time, inductive load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 3,0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	t_{don}	0,10 0,11		μs μs	
ターンオン上昇時間 (誘導負荷) Rise time, inductive load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 3,0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	t_r	0,06 0,07		μs μs	
ターンオフ遅れ時間 (誘導負荷) Turn-off delay time, inductive load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 3,0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	t_{doff}	0,53 0,55		μs μs	
ターンオフ下降時間 (誘導負荷) Fall time, inductive load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 3,0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	t_f	0,03 0,04		μs μs	
ターンオンスイッチング損失 Turn-on energy loss per pulse	$I_C = 300\text{A}, V_{CE} = 600\text{V}, L_S = 60\text{nH}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 3,0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	E_{on}	25,0		mJ mJ	
ターンオフスイッチング損失 Turn-off energy loss per pulse	$I_C = 300\text{A}, V_{CE} = 600\text{V}, L_S = 60\text{nH}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 3,0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	E_{off}	15,0		mJ mJ	
短絡電流 SC data	$V_{GE} \leq 15\text{V}, V_{CC} = 900\text{V}$ $V_{CE\text{max}} = V_{CES} - L_{SCE} \cdot di/dt$	$t_P \leq 10\mu\text{s}, T_{vj} = 125^{\circ}\text{C}$	I_{SC}	2000		A	
ジャンクション・ケース間熱抵抗 Thermal resistance, junction to case	IGBT部 (1素子当り) / per IGBT		R_{thJC}		0,064	K/W	
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	IGBT部 (1素子当り) / per IGBT $\lambda_{\text{Paste}} = 1\text{W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1\text{W}/(\text{m}\cdot\text{K})$		R_{thCH}	0,019		K/W	
動作温度 Temperature under switching conditions			$T_{vj\text{op}}$	-40	125	$^{\circ}\text{C}$	

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暫定データ
Preliminary Data

ダイオード-直列 / Diode-serial
最大定格 / Maximum Rated Values

ピーク繰返し逆電圧 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1200	V
連続DC電流 Continuous DC forward current		I_F	300	A
ピーク繰返し順電流 Repetitive peak forward current	$t_P = 1 \text{ ms}$	I_{FRM}	600	A
電流二乗時間積 I^2t - value	$V_R = 0 \text{ V}, t_P = 10 \text{ ms}, T_{vj} = 125^{\circ}\text{C}$	I^2t	18000	A^2s

電気的特性 / Characteristic Values

			min.	typ.	max.	
順電圧 Forward voltage	$I_F = 300 \text{ A}, V_{GE} = 0 \text{ V}$ $I_F = 300 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	V_F	2,00 1,70	2,55	V V
ピーク逆回復電流 Peak reverse recovery current	$I_F = 300 \text{ A}, -di_F/dt = 4500 \text{ A}/\mu\text{s} (T_{vj}=125^{\circ}\text{C})$ $V_R = 600 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	I_{RM}	230 300		A A
逆回復電荷量 Recovered charge	$I_F = 300 \text{ A}, -di_F/dt = 4500 \text{ A}/\mu\text{s} (T_{vj}=125^{\circ}\text{C})$ $V_R = 600 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	Q_r	18,0 42,0		μC μC
逆回復損失 Reverse recovery energy	$I_F = 300 \text{ A}, -di_F/dt = 4500 \text{ A}/\mu\text{s} (T_{vj}=125^{\circ}\text{C})$ $V_R = 600 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	E_{rec}	7,00 15,0		mJ mJ
ジャンクション・ケース間熱抵抗 Thermal resistance, junction to case	/Diode (1 素子当り) / per diode		R_{thJC}		0,10	K/W
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	/Diode (1 素子当り) / per diode $\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$		R_{thCH}	0,029		K/W
動作温度 Temperature under switching conditions			$T_{vj \text{ op}}$	-40	125	$^{\circ}\text{C}$

ダイオード、リバーサ / Diode, Reverse
最大定格 / Maximum Rated Values

ピーク繰返し逆電圧 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1200	V
連続DC電流 Continuous DC forward current		I_F	100	A
ピーク繰返し順電流 Repetitive peak forward current	$t_P = 1 \text{ ms}$	I_{FRM}	200	A
電流二乗時間積 I^2t - value	$V_R = 0 \text{ V}, t_P = 10 \text{ ms}, T_{vj} = 125^{\circ}\text{C}$	I^2t	4000	A^2s

電気的特性 / Characteristic Values

			min.	typ.	max.	
順電圧 Forward voltage	$I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$ $I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	V_F	2,00 1,70	2,55	V V
ジャンクション・ケース間熱抵抗 Thermal resistance, junction to case	/Diode (1 素子当り) / per diode		R_{thJC}		0,30	K/W
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	/Diode (1 素子当り) / per diode $\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$		R_{thCH}	0,087		K/W
動作温度 Temperature under switching conditions			$T_{vj \text{ op}}$	-40	125	$^{\circ}\text{C}$

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モジュール / Module

絶縁耐圧 Isolation test voltage	RMS, f = 50 Hz, t = 1 min	V _{ISOL}	2,5		kV
内部絶縁 Internal isolation	基礎絶縁 (クラス1, IEC 61140) basic insulation (class 1, IEC 61140)		Al ₂ O ₃		
沿面距離 Creepage distance	連絡方法 - ヒートシンク / terminal to heatsink 連絡方法 - 連絡方法 / terminal to terminal		20,0		mm
空間距離 Clearance	連絡方法 - ヒートシンク / terminal to heatsink 連絡方法 - 連絡方法 / terminal to terminal		11,0		mm
相対トラッキング指数 Comperative tracking index		CTI	> 425		
			min.	typ.	max.
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	/モジュール / per module $\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$	R _{thCH}		0,01	K/W
内部インダクタンス Stray inductance module		L _{sCE}		20	nH
パワーターミナル・チップ間抵抗 Module lead resistance, terminals - chip	T _c = 25°C, /スイッチ / per switch	R _{CC+EE'}		0,70	mΩ
保存温度 Storage temperature		T _{stg}	-40		125 °C
取り付けネジ締め付けトルク Mounting torque for modul mounting	取り付けネジ M6 適切なアプリケーションノートによるマウンティング Screw M6 - Mounting according to valid application note	M	3,00	-	6,00 Nm
主端子ネジ締め付けトルク Terminal connection torque	取り付けネジ M6 適切なアプリケーションノートによるマウンティング Screw M6 - Mounting according to valid application note	M	2,5	-	5,0 Nm
質量 Weight		G		340	g

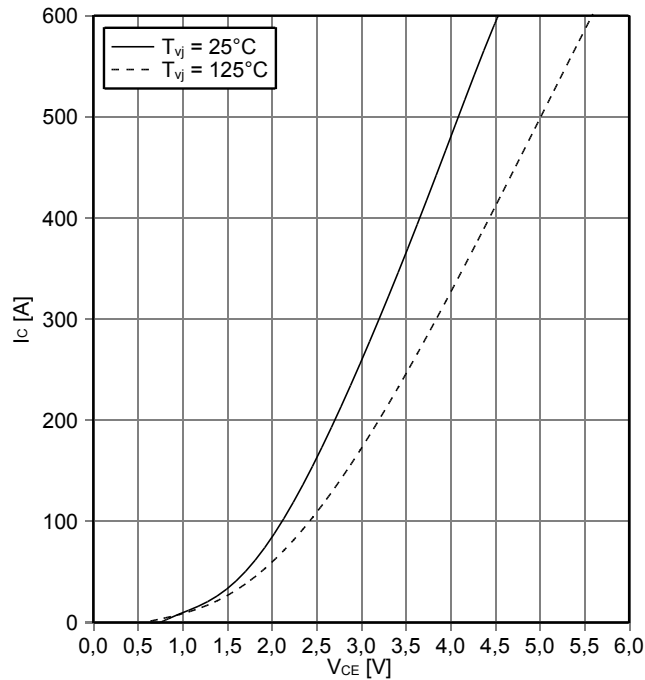
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Preliminary Data

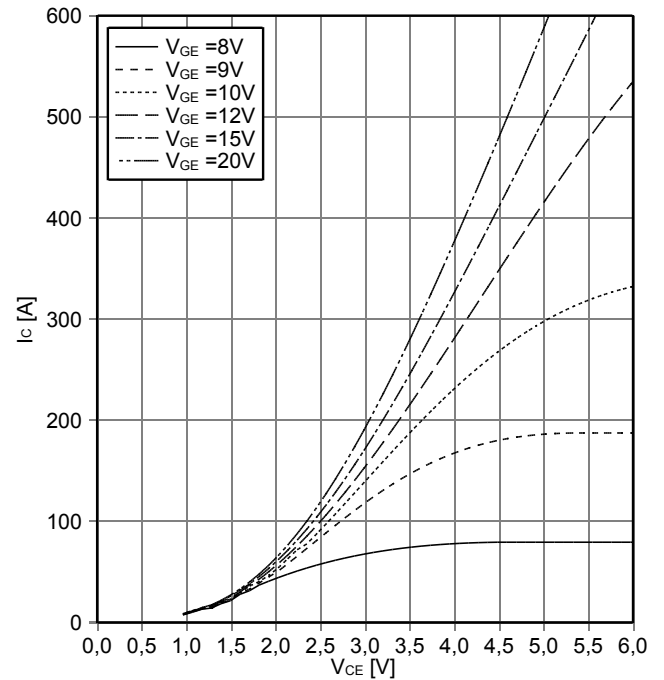
出力特性 IGBT-ブレーキチョッパー (Typical)
output characteristic IGBT, Brake-Chopper (typical)

$I_c = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



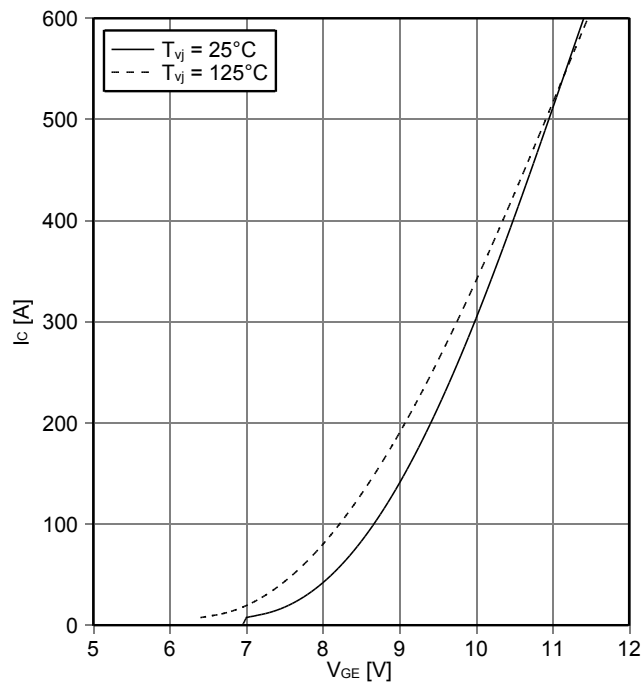
出力特性 IGBT-ブレーキチョッパー (Typical)
output characteristic IGBT, Brake-Chopper (typical)

$I_c = f(V_{CE})$
 $T_{vj} = 125^\circ\text{C}$



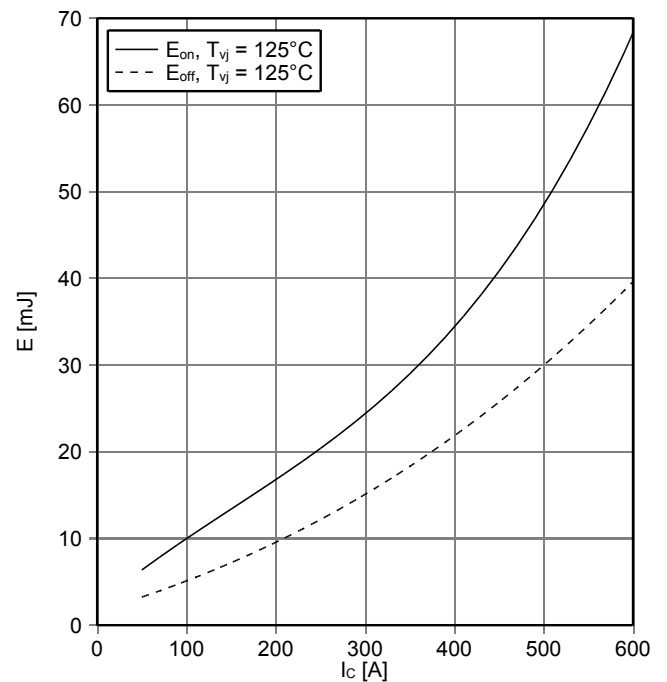
伝達特性 IGBT-ブレーキチョッパー (Typical)
transfer characteristic IGBT, Brake-Chopper (typical)

$I_c = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



スイッチング損失 IGBT-ブレーキチョッパー (Typical)
switching losses IGBT, Brake-Chopper (typical)

$E_{on} = f(I_c)$, $E_{off} = f(I_c)$
 $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 3\ \Omega$, $R_{Goff} = 3\ \Omega$, $V_{CE} = 600\text{ V}$



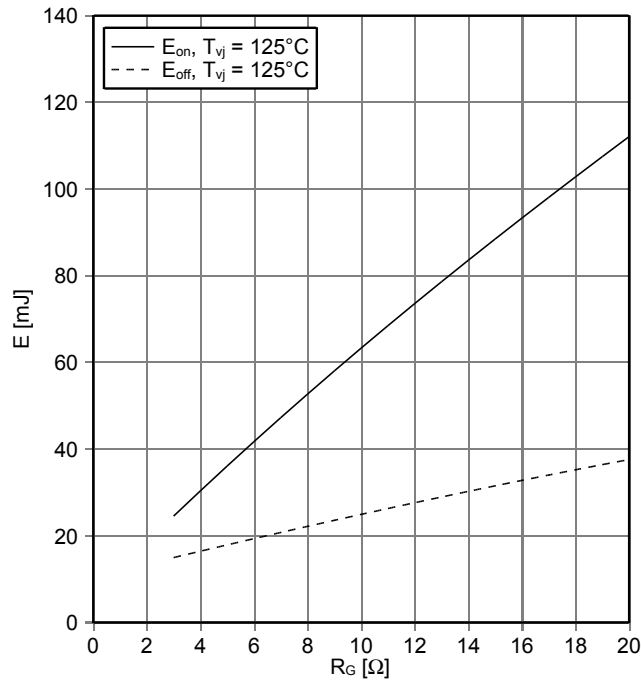
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暫定データ
Preliminary Data

スイッチング損失 IGBT-ブレーキチョッパー (Typical)
switching losses IGBT, Brake-Chopper (typical)

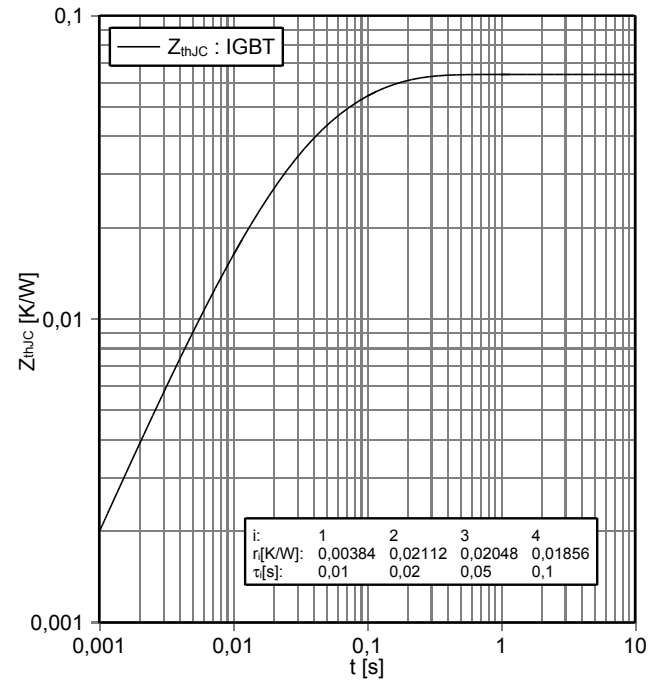
$E_{on} = f(R_G), E_{off} = f(R_G)$

$V_{GE} = \pm 15\text{ V}, I_C = 300\text{ A}, V_{CE} = 600\text{ V}$



過渡熱インピーダンス IGBT-ブレーキチョッパー
transient thermal impedance IGBT, Brake-Chopper

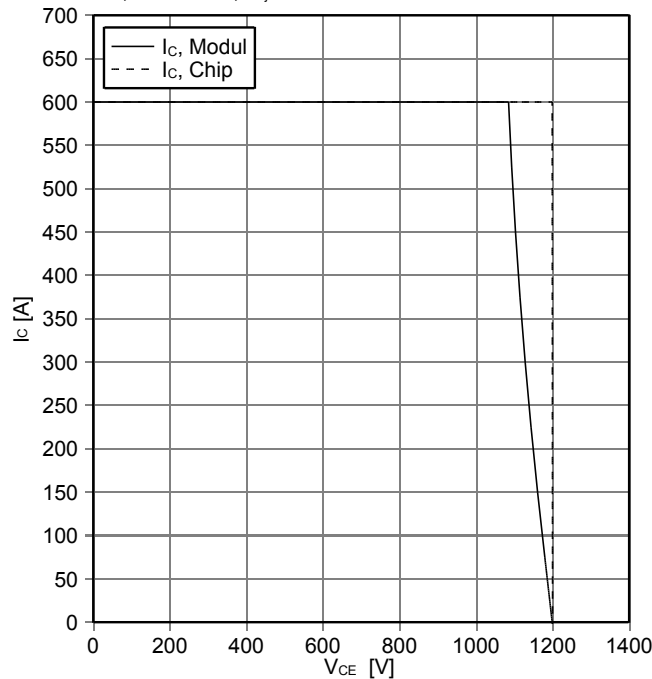
$Z_{thJC} = f(t)$



逆バイアス安全動作領域 IGBT-ブレーキチョッパー (RBSOA)
reverse bias safe operating area IGBT, Brake-Chopper (RBSOA)

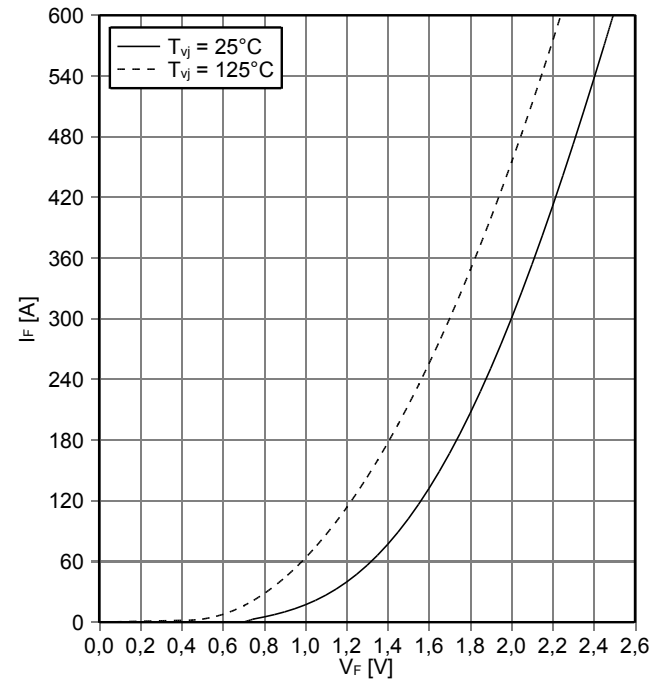
$I_C = f(V_{CE})$

$V_{GE} = \pm 15\text{ V}, R_{Goff} = 3\ \Omega, T_{vj} = 125^\circ\text{C}$



順電圧特性 ダイオード-直列 (typical)
forward characteristic of Diode-serial (typical)

$I_F = f(V_F)$



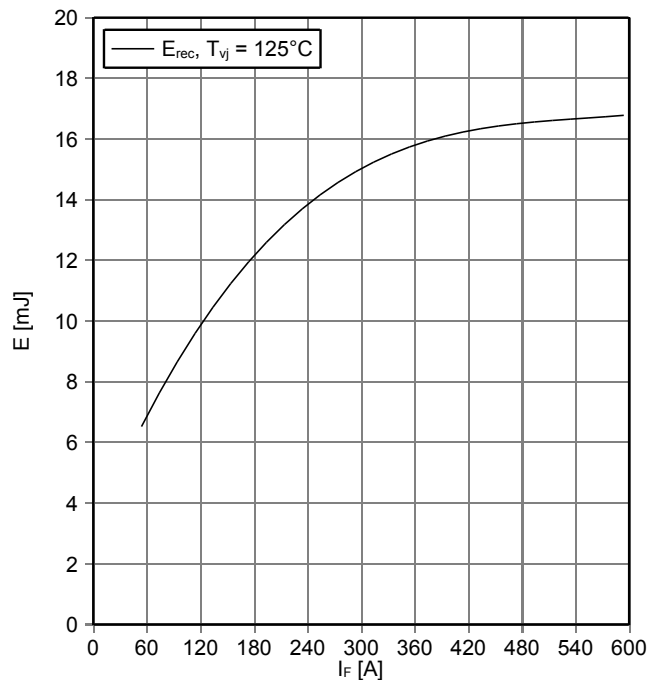
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Preliminary Data

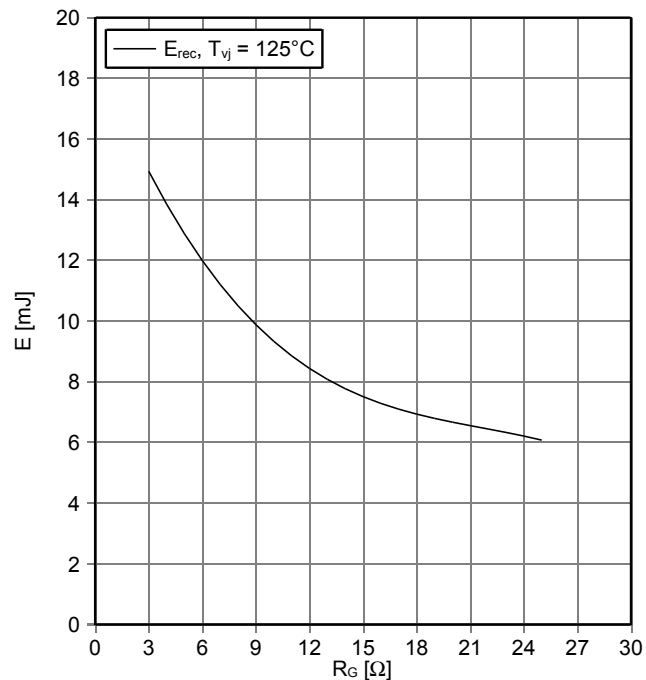
スイッチング損失 ダイオード-直列 (Typical)
switching losses Diode-serial (typical)

$E_{rec} = f(I_F)$
 $R_{Gon} = 3 \Omega, V_{CE} = 600 V$



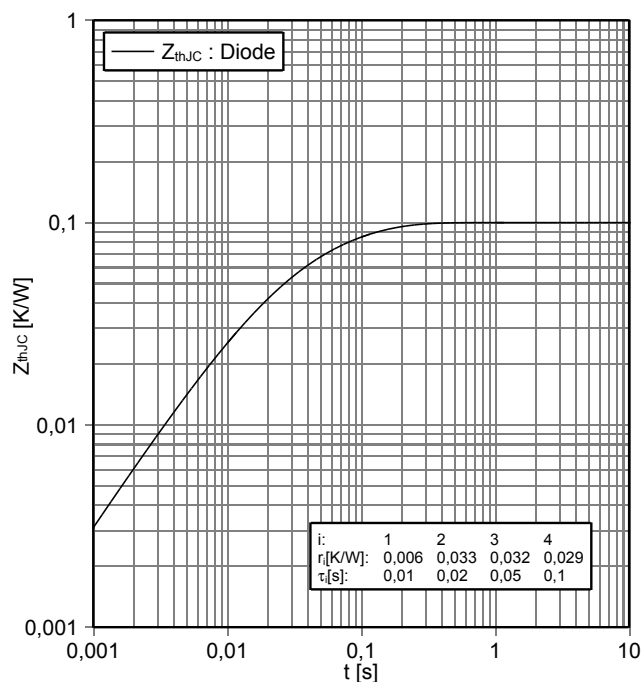
スイッチング損失 ダイオード-直列 (Typical)
switching losses Diode-serial (typical)

$E_{rec} = f(R_G)$
 $I_F = 300 A, V_{CE} = 600 V$



過渡熱インピーダンス ダイオード-直列
transient thermal impedance Diode-serial

$Z_{thJC} = f(t)$

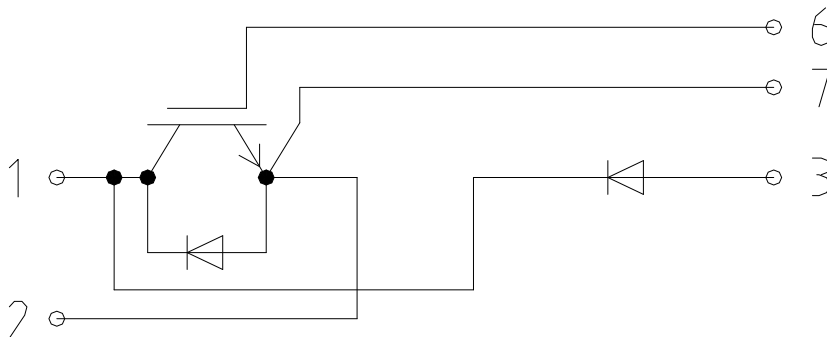


i:	1	2	3	4
r_i [K/W]:	0,006	0,033	0,032	0,029
τ_i [s]:	0,01	0,02	0,05	0,1

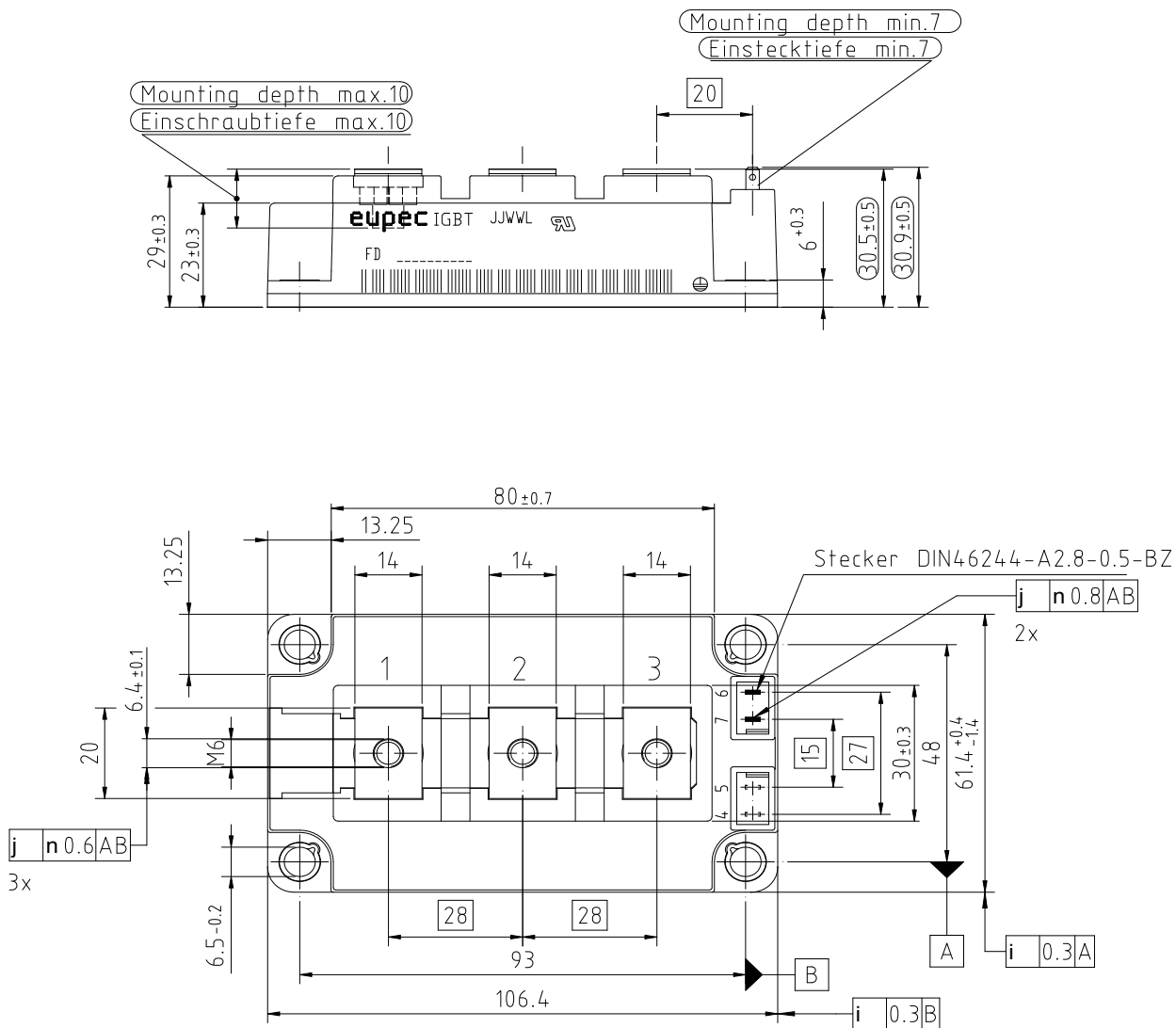
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回路図 / circuit_diagram_headline



パッケージ概要 / package outlines



Freimaßtoleranzen nach ISO2768 mH General tolerance ISO2768 mH

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